



Product Change Notification

Change Notification #: 117014 - 00
Change Title: Intel® Server System R2308WTTYSR, Intel® Server System R2312WTTYSR, PCN 117014-00, Label, Add URL of BIS mark to power supply label
Date of Publication: June 19, 2019

Key Characteristics of the Change: Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	July 5, 2019
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*Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is updating the labels of the power supply 1100W included in the Intel® Server Systems R2308WTTYSR and R2312WTTYSR. The new labels adds a URL of the BIS mark.

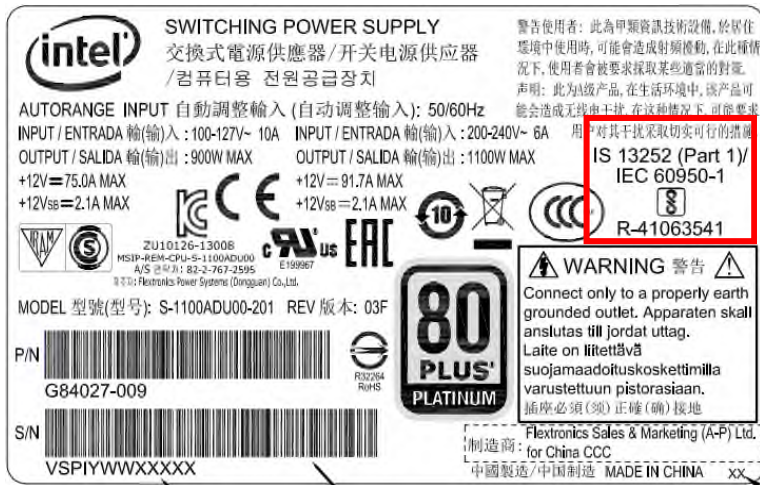


Image 1. Power supply label before change

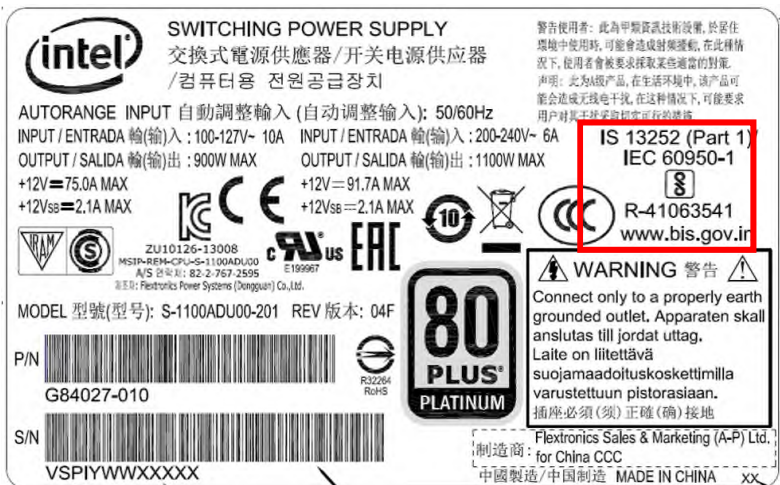


Image 2. Power supply label after change

Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R2308WTTYSR	975760	J11493-015	J11493-016
R2312WTTYSR	975761	J11495-017	J11495-018

PCN Revision History:

Date of Revision:

June 19, 2019

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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